

Huntron Access USB Huntron Access 2 USB

USER'S MANUAL

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Contacting Huntron

To obtain information about service, accessories and other products, contact:

Huntron Inc.

15720 Main Street, Suite#100 Mill Creek, WA 98012 USA Phone: 800-426-9265 or 425-743-3171 FAX: 425-743-1360 E-mail: info@huntron.com Website: www.huntron.com

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SECTION 1 INTRODUCTION

1-1 Introduction

Huntron Access USB probers are universal test fixtures for accessing test points on printed circuit assemblies. Throughout this manual all models will be referred to as Huntron Access except to explain the differences between the models. The Huntron Access provides physical access to fine pitched Printed Circuit Assemblies (PCAs). When combined with any test instrument like a Digitizing multi-meter, Oscilloscope, Signal Generator, LCR meter, Functional Tester, In-circuit Tester, Analog Signature Analyzer or any custom test instrument, the Huntron Access allows test engineers and technicians to test and troubleshoot their difficult and elusive problems on PCAs. The Huntron Access USB with Tracker and Huntron Access 2 USB with Tracker have a Tracker Model 30 built inside that is referred to as the Access Tracker.

The user can replace the built-in test probe with a custom probe suitable for the user's custom application. The Z-axis consisting of the Probe, Motor Electronics and Camera, can be replaced by a user specified Z-axis.

The Huntron Access basically consists of three axes which move a test probe along an XY plane. Once the probe reaches an XY coordinate, an up or down Z movement can be initiated so that the test probe makes contact with a test point on the target printed circuit board. Each X, Y and Z stage is driven by a separate stepper motor.

The color camera installed on the Z axis displays a high resolution image of the printed circuit assembly on the PC monitor. Using linear encoders and micro-stepping, accurate and repeatable movements can be achieved.

The Access 2 NFSA includes a NFSA Probe. The Access 2 NFSA Ready can have a NFSA Probe added. The NFSA Probe provides local synthetic measurement technology including the sensor, receiver and signal processing in one compact RF Probe assembly allows the sensing of EM fields emanating from RF circuitry. A specific position in a Near Field is defined as a Virtual Test Point[™] (VTP) where a NFSA measurement is made. Identical circuits emanate nearly identical fields at the VTP. The combination of Huntron Prober and TEV NFSA Probe allows accurate positioning and measurement of VTPs. See the NFSA Probe Manual for more information.

This Manual covers the following products:

Access USB, Access 2 USB, Access USB with Tracker, Access 2 USB with Tracker, Access 2 NFSA, Access 2 NFSA Ready.

1-2 Features

A complete troubleshooting workstation consists of a PC, Huntron Access and a Test Instrument or built-in Access Tracker.

Hardware Features of the Huntron Access

- The XYZ stages are stainless steel linear raceways providing an accurate means of moving a light load.
- Uses linear encoders for the X and Y axes which provide feedback for error correction
- The linear stages use fine pitched toothed timing belts which are driven by stepper motors.
- Micro-stepping drivers can micro-step the stepper motors to 4000 steps/revolution allowing a 0.3937 mil or 10 microns resolution. The Micro-stepping mode is automatically selected depending on the distance moved.
- A patented versatile clamping system provides an easy means of clamping the printed circuit assembly so that the moving probe can access either the solder or component side without the need for additional fixturing.
- Connection to any external tester is via two BNC connectors mounted at the back of the Huntron Access. The Probe BNC connector is for the Signal from the external tester, and the Common BNC is for the ground of the external tester.
- The Probe BNC connector is routed to the test probe via a flexible low impedance coaxial cable.
- A camera mounted on the side of the Z axis produces a digitized color image of an area of the printed circuit assembly on the PC monitor. This is a high-resolution color camera with adjustable focus and aperture is used. Not included with NFSA versions of the Access 2.
- A camera mounted on the front of the Z axis allows a view of the probe tip.
- Magnetic proximity limit switches are used to define the "home" position.
- The test probe tip mounted on the Z axis is a removable standard "bed-of-nails" type spring loaded probe tip. Different probe tips are supplied covering conformal coating applications to fine pitched crown pointed tips.
- A built-in frame grabber connected to the camera on the side of the Z axis is used to display live images of the printed circuit assembly on the PC monitor. Digitizing test points then involves clicking on the pixels of the camera image.
- The Base Cover of the system can be removed for convenient access to components and other test points, allowing the printed circuit assembly to be powered by a customer supplied power supply.
- The spring loaded probe on the Z axis can be directly wired to any Oscilloscope probe via the optional Auxiliary Scope Probe Kit. Custom cables from the customer's test equipment can also be wired to connect to the probe pin.
- All flexible cables are shielded.
- An STOP switch allows immediate suspension of Huntron Access movement.

- There are 5 Common connectors accessible at the front panel which allows connection to the printed circuit assembly signal reference points.
- Huntron Access USB with Tracker and the Huntron Access 2 USB with Tracker have a built in Access Tracker (Model 30) that creates a complete test system.
- Huntron Access 2 NFSA has a Near Field Signature Analysis (NFSA) Probe.

Software applications for the Huntron Access

- Can be used with the Huntron Workstation software for power-off troubleshooting of Printed Circuit Assemblies.
- Can be used with the Huntron Workstation software for Near Field Signature Analysis troubleshooting of RF Printed Circuit Assemblies (NFSA models only).
- Optional Huntron Workstation Remote Control allows Huntron Workstation to be controlled by custom programs.
- Optional Huntron SDK allows creation of custom programs to control the Huntron Access and Huntron Trackers.



Figure 1-1 Huntron Access 2 USB and Huntron Access USB

1-3 Specifications

Specification	Huntron Access USB	Comments
	Huntron Access USB w/Tracker	
Physical Dimensions	26.5" W, 24.5" D, 13" H	
	67.31 cm W, 62.3 cm D, 33.02 cm H	
Max. board-under-test	19.4" W by 14" D	Max thickness is 0.1" (2.54mm)
size	(49.276 cm W by 35.56 cm D)	
Max board probing area	15.3" W by 12.9" D	Area of the board that the probe
	(38.86 cm W by 32.77 cm D)	can reach without re-adjusting the
		position of the board
Max allowable	2.375" H (6.03 cm)	Measured from the lowest slot
component height		
# of PCB guide slots	3	
Max Z Travel	2.21" (5.61 cm)	Maximum allowable up/down
		movement
Linear speed	5 inches/sec (12.7 cm/SEC)	Speed in the X or Y direction
Minimum resolution	0.3937 mil (0.0003937") (10 microns)	Minimum allowable movement in
		the X or Y direction
Probing Accuracy	+/-0.7874 mil (0.0007874") (20	Over a travel distance of 10"
	microns)	(25.4 cm)
Vision system	CCD	
	811(H) x 508(V) Color	
Light Source	White LED array w/adjustable	
	Intensity	
Lens system	25mm Focal Length C mount with	
	adjustable focus and aperture	
Frame Grabber	USB	
Linear Encoder	Resolution 0.3937 mils (10 microns)	
Micro stepping	Stepper motor automatically	
	adjusted.4000 micro-steps per	
	revolution	
Weight	63 lbs. (28.64 kg)	Unit only
Mechanical Drive	6 mm Wide steel reinforced Timing	
System	belt.	
	Steel linear raceways.	
Power requirements	115V~ 1.0A 60Hz	
	230V~ 0.5A 50HZ	
Fuse	T1A 5x20mm 250V	
Probe Connection	Maximum 250V~/3A	
Computer interface	USB 2.0	
Operating temperature	59 degrees F to 86 degrees F	

Specifications of Huntron Access USB Models

	(+15 degrees C to +30 degrees C)	
Storage temperature	-58 degrees F to 140 degrees F	
	(-50 degrees C to +60 degrees C)	
Operating Humidity	45 to 70% R.H.	
Storage Humidity	0 to 70% R.H.	
Use	Indoor Use Only	
Operating Altitude	6,560ft (2,000m)	
Storage Altitude	32,800ft (10,000m)	
Mains Supply Voltage	Up To +/-10% of the Nominal Voltage	
fluctuations		
Transient Over Voltages	Up to levels of Over Voltage Category	
	II; NOTE 1 These levels of transient	
	overvoltage are typical for equipment	
	supplied from the building wiring.	
Wet Location	N/A	
Applicable Pollution	Pollution Degree 2	
Z axis weight	Existing 3.5 lbs.	Without NFSA Probe
	Max 5.0 lbs.	
Probe weight	1 lbs. max.	Without NFSA Probe
Probe down force	70.5 oz. max.	Without NFSA Probe
Web cam	USB	Not on Access NFSA
Tracker specifications	See Access Tracker Specifications	
	(Access USB w/Tracker only)	
Safety considerations	Front panel STOP switch for stopping	CE mark and ETL listed
	motors	

	1	1
Specification	Huntron Access 2 USB Huntron Access 2 USB with Tracker	Comments
	Huntron Access 2 NFSA	
	Huntron Access 2 NFSA Ready	
Physical Dimensions	36" W, 29" D, 15.7" H	
	(91.44 cm W, 73.66 cm D, 39.88	
	cm H)	
Max. board-under-test	22" W by 23" D	Max thickness is 100 mils (2.54mm)
size	(55.88 cm W by 58.42 cm D)	
Max board probing area	18.2" W by 22.4" D	Area of the board that the probe can
	(46.22 cm W x 56.90 cm D)	reach without re-adjusting the position
	Access 2 NFSA and Access 2	of the board.
	NFSA Ready Probing Area	
	15.3" W by 18.0" D	
	(38.8 cm W x 45.7 cm D)	
Max allowable	4" H (10.16 cm H)	Measured from the lowest slot
component height		
# of PCB guide slots	4	
Max Z Travel	4.21" (10.7cm)	Maximum allowable up/down
		movement
Linear speed	4 inches/sec (10.16 cm/sec)	Speed in the X or Y direction
Minimum resolution	0.3937 mil (0.0003937")	Minimum allowable movement in the X
	(10 microns)	or Y direction
Probing Accuracy	+/-0.7874 mil (0.0007874")	Measured over a travel distance of 10"
	(+/- 20 microns)	(25.4 cm)
Vision system	CCD	
	811(H) X 508 (V) Color	
Light Source	White LED array w/adjustable	
_	Intensity	
Lens system	25mm Focal Length C mount	
	with adjustable focus and aperture	
Frame Grabber	USB	
Weight	140 lbs (63.64 kg)	Unit only
Mechanical Drive	6mm wide steel reinforced timing	• •
System	belt	
	Stainless steel linear rails	
Power requirements	115V~ 1.0A 60Hz	
	230V~ 0.5A 50HZ	
Fuse	T1A 5x20mm 250V	
Probe Connection	Maximum 250V~/3A	
Computer interface	USB 2.0	
Operating temperature	59 degrees F to 86 degrees F	
	(+15 degrees C to +30 degrees C)	

Specifications of Huntron Access 2 USB Models

Storage temperature	-58 degrees F to 140 degrees F	
	(-50 degrees C to +60 degrees C)	
Operating Humidity	45 to 70% R.H.	
Storage Humidity	0 to 70% R.H.	
Use	Indoor Use Only	
Operating Altitude	6,560ft (2,000m)	
Storage Altitude	32,800ft (10,000m)	
Mains Supply Voltage	Up To +/-10% of the Nominal	
fluctuations	Voltage	
Transient Over Voltages	Up to levels of Over Voltage	
	Category II; NOTE 1 These	
	levels of transient overvoltage are	
	typical for equipment supplied	
	from the building wiring.	
Wet Location	N/A	
Applicable Pollution	Pollution Degree 2	
Linear Encoder	Resolution 0.3937 mils (10	
	micron)	
Micro stepping	Stepper motor automatically	
	adjusted 4000 micro-steps per	
	revolution	
Z axis weight	Existing 3.7lb	Without NFSA Probe
	Max 5.0lb	
Probe weight	Max 11b max	Without NFSA Probe
Probe down force	Max 70.5oz max	Without NFSA Probe
Web cam	USB	Not on Access NFSA
Tracker specifications	See Access Tracker	
	Specifications (Access 2	
	w/Tracker only)	
Safety considerations	Front panel STOP switch for	
	stopping motors	

Specifications of NFSA Probe

For these specifications see the NFSA Probe Manual.

Specifications for Access Tracker

Electrical	Specifications subject to change without
	notice
Open Circuit Voltage (Vs):	
24 selections of peak voltage:	200mV, 400mV, 600mV, 800mV, 1V to
	20V in 1V steps including 10V (Low),
	15V (Med 1), 20V (Med 2)
Source Resistance (Rs):	
16 selections of resistance:	$10\Omega, 20\Omega, 50\Omega, 100\Omega, 200\Omega, 500\Omega, 1k\Omega,$
	$2k\Omega$, $5k\Omega$, $10k\Omega$, $20k\Omega$, $50k\Omega$, $100k\Omega$,
	54kΩ (Low), 1.2kΩ (Med 1), 26.7kΩ
	(Med 2)
Short circuit current (Vs divided by Rs)	
Maximum	200 mApk
Frequency (fs):	
40 selections of frequency:	20Hz to 190Hz in 10Hz steps; 200Hz to
	1.9kHz in 100Hz steps; 2kHz to 5kHz in
	1kHz steps
Channels	
Number	2
Connections	BNC and Banana (Channel A, Common,
	Channel B)
Over Voltage Protection	Circuit breaker

1-4 Safety Information (Information sur la sécurité)

Symbols and Warnings: (Symboles et avertissements)

The following symbols are used either in this manual or on the unit:

Les symboles suivants sont utilisés soit dans ce manuel ou sur l'appareil:

Protective Ground (Earth) Terminal: Do not disconnect any protective ground wires.

Rez de protection (terre): Ne débranchez pas les fils de terre de protection.



- **CAUTION:** This symbol is used in the user's manual as a warning that improper use could result in unit malfunctioning. For your safety always follow the instructions next to the symbol on the unit and in the manual.
- **ATTENTION**: Ce symbole est utilisé dans le manuel de l'utilisateur comme un avertissement que l'usage abusif peut entraîner des dysfonctionnements unité. Pour votre sécurité toujours suivre les instructions à côté du symbole de l'unité et dans le manuel.



This symbol warns the user that spring loaded probe which is mounted on the Z axis is sharp and can scratch or punch the skin.

Ce symbole prévient l'utilisateur que la sonde à ressort qui est monté sur l'axe Z est net et peuvent rayer ou le poinçon de la peau.



This symbol warns the user that this is a pinch point / Crush hazard were the Z axis and X axis move to their limits forward/back and left/right. The user should not have their fingers or hands near this point while the unit is in motion.

Ce symbole prévient l'utilisateur qu'il s'agit d'un point de pincement / écrasement de risque étaient l'axe Z et l'axe X sont à placer aux limites avant / arrière et droite / gauche. L'utilisateur ne devrait pas avoir les doigts ou les mains près de ce point lorsque l'appareil est en mouvement.

The all Huntron Access models conform to the following Standards: EN 55011EN 61000-3-2:2000EN 61000-3-3:1995/A1:2001EN 61000-4-2EN 61000-4-3EN 61000-4-3EN 61000-4-5EN 61000-4-6EN 61000-6-1:2001EN 61000-6-2:2001EN 61000-6-3:2001EN 61000-6-4:2001EN 61000-6-4:2001EN 61010-1:2001 (Second Edition)

Intertek Meets the Standard for Safety Requirements for Electrical Equipment for Measurement, Control and Laboratory Use; Part 1 General Requirements – UL 61010-1, 2nd Ed., with revisions through 07/22/2005, and CAN/CSA-C22.2 No. 61010-1, 2nd Ed., dated 07/12/2004.

▲ Line Fuse Replacement: (Line Remplacement des fusibles)

Voltage Select/Line Fuse tray: The power entry module includes a power switch (0 = OFF, 1 = ON), power cord connector, and a removable tray which selects the line voltage and holds the line fuses.

Tension sélectionner / Line bac Fuse: Le module d'entrée d'alimentation comprend un interrupteur d'alimentation (0 = off, 1 = ON), connecteur cordon d'alimentation, et un plateau amovible qui permet de sélectionner la tension de ligne et détient les fusibles en ligne.

Make sure that replacement fuses are of the type and current rating specified. If necessary, insert a T1A 5x20mm 250V fuse into the fuse tray.

Assurez-vous que les fusibles de remplacement sont de type et leur courant nominal spécifié. Si nécessaire, ajouter un 5x20mm T1A 250V dans le bac à fusibles.

Power Cord Replacement: (Remplacement du cordon d'alimentation)

Power Cord: Only replace the main power cord with a cord with NEMA 5-15 Power Plug and IEC 320 C13 connector. The cord must be rate at 10A and voltage of the power source used. UL listed 18AWG wire.

Cordon d'alimentation: Remplacez le cordon d'alimentation uniquement par un cordon avec prise d'alimentation NEMA 5-15 et connecteur IEC 320 C13. Le cordon doit être réglé à 10A et la tension de la source d'alimentation utilisée. Fil 18AWG.

Replacing the main power cord that does not meet the requirements can cause damage to the equipment and harm personnel.

Le remplacement du cordon d'alimentation principal qui ne répond pas aux exigences peut endommager l'équipement et blesser le personnel.

1-5 Environment Conformity Quality

For more information see our website www.huntron.com/corporate/environment.htm

Environment



Huntron is aware of the recycling needs for Waste Electronic and Electrical Equipment (WEEE) and is co-operating with systems established, worldwide for the collecting and recycling of our products.

Huntron has applied the wheeled bin recycle mark (EN50419) to our products.



Recycling is important to all communities; therefore, we ask our customers to be responsible in recycling. Please check your local recycling laws for further information.

Huntron wants to make sure that old Huntron products are responsibly recycled. As part of that goal, Huntron offers a trade-in for any one used Tracker or Prober when a new Tracker or Prober is purchased. All trade-in products are responsibly recycled. More information on Trade-in program go to <u>www.huntron.com/sales-support/repairpolicy.htm</u>.

Conformity

Huntron products are classified as Category 9 industrial monitoring and control instruments. Our manufacturing processes conform to our standards. These include regulation and directives like RoHS2, REACH and Conflict Minerals. See our Declaration of Conformity to Huntron Quality Standard at

www.huntron.com/corporate/docs/conformity.pdf.

Quality

Huntron has been producing quality products and supporting customers all over the world for several decades. Our products conform to our Quality Manual. For information see our Quality Statement at <u>www.huntron.com/corporate/docs/quality-statement.pdf</u>.

SECTION 2 THEORY OF OPERATION

2-1 Introduction

The purpose of this section is to simply explain the functional characteristics of the main components of the Huntron Access system.

2-2 Functional Overview

The Test probe on the Z axis is directly connected to the BNC Probe connector located on the side or back panel. The vision system displays an image of a small area of the printed circuit assembly on the PC monitor for setting up the XY locations of test points.

2-3 Stepper Motor Controller

The Stepper Motor Controller receives ASCII commands from the PC. The controller applies direction pulses for clockwise or counter-clockwise rotation and step pulses at different frequencies to the motor driver.

2-4 Stepper Motor Drivers

The purpose of the Motor Drivers is to supply sufficient and regulated current to each phase of the motor winding. The Motor driver uses micro-stepping, dividing each motor step into fractional steps, thus allowing very small movements useful for accuracy and error correction. Each 0.9 degree step of the stepper motor can be further subdivided into 4000 micro-steps, resulting in a minimum movement of 10 microns or 0.3937 mils.

2-5 Linear Encoders

Linear encoders are used to report to the system the exact location of the Z axis housing which holds the test probe. Optical readers mounted in each axis read the engraved lines on a metal tape. These lines are spaced 10 microns or 0.3937 mils apart. The optical reader automatically outputs signals to the controller, thus reporting its position after every movement. The reported position is then compared to the theoretical position and corrections are made by the control software. The linear encoder serves as the most important function for maintaining accuracy of movements.

2-6 Vision System

The vision system consist of a high-resolution color analog camera mounted on the side of the Z axis and the Probe Tip camera mounted on the front of the Z axis (not available NFSA Models). The color camera is capable of 480 lines of horizontal resolution in the NTSC (rs-170) format. It has automatic background compensation, which allows for digital brightness control on low or highlighting conditions. The camera uses a standard 25 mm C mount lens that has aperture and focus control. The aperture and focus adjustments can be locked into position via set screws or knobs. The Probe Tip camera is focused by turning the lens and positioned by loosening the screw in the clamp.

The color camera output is connected to an internal frame grabber that is connected to the internal USB hub, which is connected to external USB connector.

A Ring light source with intensity control is mounted around the color camera lens. It uses 8 super bright white LEDs, which produce, diffuse and evenly distributed white light.

2-7 Controls and Signal Connections

Safety Stop Switch

The safety stop switch is located on the right side of the Huntron Access. Depressing this stop switch will cause all motor movement in the X and Y directions to immediately stop and have their respective power turned off. If the Z axis was in the depressed position (down position), it will automatically move up to its home position, thus relieving any pressure that was put on the board-under-test. The Z motor power will still be on, thus preventing the Z axis from being further depressed due to gravity or other forces. The software will detect that the STOP switch was depressed and will not allow the user to continue operating the unit. The stop switch light illuminated in green indicates that the power is turned on.

The STOP switch can be used for the following purposes:

- Stop X and Y Motor operations and turn the motor power off.
- Move the Z probe up to its home position.
- Interrupt all further instruction from the computer and stop all operations.

Signal Banana Jack (Access With Tracker Only)

This banana jack is connected to **Channel B** of the internal Access Tracker. It can be used to connect a hand probe for manual probing.

Common Banana Jack

This banana jack is connected to the Common BNC and the internal Access Tracker Common (With Tracker Only).

Common 1 Banana Jack

This banana jack is connected to an internal software controlled relay that connects to Common BNC when activated.

Common 2 Banana Jack

This banana jack is connected to an internal software controlled relay that connects to Common BNC when activated.

Common 3 Banana Jack

This banana jack is connected to an internal software controlled relay that connects to Common BNC when activated.

Common 4 Banana Jack

This banana jack is connected to an internal software controlled relay that connects to Common BNC when activated.

USB Port

This USB port is used to connect the Huntron Access to a PC.

Probe BNC

This BNC is connected to the probe tip of the Huntron Access. It is used to connect external instruments to the probe tip. It is also used to connect to Channel A BNC to use the internal Access Tracker (With Tracker Only).

Common BNC

This BNC is connected to the Common banana jack and the internal Access Tracker Common (With Tracker Only).

Not Used / Channel A (With Tracker Only) / Camera (USB/PCI Only) BNC

Access With Tracker Only: This BNC is connected to the internal Access Tracker Channel A and is used to connect to the Probe BNC to connect the Access Tracker to the probe tip.

USB/PCI Only: This BNC is connected to the Camera on the Z head for connection to a PCI/PXI frame grabber. The internal USB frame grabber is disconnected from the camera.

Z Probe USB

This USB connector that is on some models is for connecting the Probe Tip camera or NFSA Probe USB cables. It is a standard USB connection the internal USB hub in the prober. The hub is only powered when the prober is on.

Z Probe Tip BNC

This BNC is connected to the wire that runs down to the probe tip.

Z Probe NFSA BNCs

These BNCs are on some models and are internal shorted and are for connecting the NFSA Ground to the Probe BNC cable.

Z Probe NFSA Power Jack

This jack on some models is to provide 12V power to the NFSA Probe.

Not Used / Auxiliary (AUX) Connector (Access With Tracker Only)

The Auxiliary (AUX) 9 pin DIN connector pins are shown below. These pins can be used for synchronizing and triggering the Access Tracker with other external Functional Test Instrumentation.



Fig 9. Rear panel 9 pin Din connector pin outs.

Pin 1: SINE. Output Sine wave synchronized with the applied sine wave signal at the BNC Signal or Banana jack Signal connector. This is used for externally verifying the internal digitizer operation.

Pin 2: AGND. Analog ground is the ground for the SINE and SINE ZC outputs.

Pin 3: SINE ZC. Output zero crossing signal for the sine wave of pin 1.

Pin 4: LINE OUT. The normally Low state can be driven to High state via software control for detection by external instrumentation.

Pin 5: LINE IN. The normally High state can be externally shorted to GND to drive it Low for detection by the software.

Pin 6: TRIG OUT. Similar to LINE OUT signal.

Pin 7: TRIG IN. Similar to LINE IN.

Pin 8: GND. Reference ground for ZC, LINE OUT, LINE IN, TRIG OUT and TRIG IN.

Pin 9: OUT ON. The normally Low state is automatically driven to High state whenever the output sine wave signals are present at the BNC or Banana connectors.

SECTION 3 INSTALLATION

3-1 Huntron Workstation Software

The Access USB probers are controlled by Huntron Workstation Software.

Note: For instructions on installing the software, see the Getting Started document that comes with the Huntron Access USB Probers.

3-2 Installing the Hardware

- 1. Locate the unpacking sheet that was supplied with the Huntron Access.
- 2. Follow the unpacking steps as outlined in the unpacking sheet.
- 3. Make sure the Red stop blocks and Z Probe Locking Screw or Pin have been removed.
- 4. Select the Line Voltage: The power entry module includes the power switch (0 = OFF, 1 = ON), power cord connector, and a removable fuse tray which selects the line voltage and holds the line fuses. If the correct voltage is not selected, open the tray door, remove the fuse tray. Turn the fuse tray over and reinsert and close the door. The correct voltage should be visible when the tray door is closed.

3-3 Mounting the NFSA Probe (Access 2 NFSA Only)



- 1. Manually move the Z Head of the Access to the front center.
- 2. Pull the Z Probe all the way down.
- 3. Remove the Probe wire from the Probe receptacle.
- 4. Remove the 3-48 3/8" screw (P/N 07-3208) and the 3-48 lock nut (P/N 07-3250) holding the Probe Block to the Z Rail.
- 5. Use the Allen Wrench to push the screw out of the hole.
- 6. Remove the Probe Block from the Z Rail.
- 7. Re-install screw 3-48 x 3/8" (07-3208) & nut (07-3250) in the Probe Block and place in the NFSA case.
- 8. Remove the NFSA Probe (P/N 98-0528), Bracket, Mounting NFSA Probe (P/N 01-3505) and Probe Mounting Block Access 2 NFSA P/N 01-3490 from the kit.
- 9. Attach the NFSA Probe to the Mounting Block securing the NFSA Probe between the Mounting Block and Mounting bracket using the three 6-32 1/2" screws (P/N 07-3166) in the kit.
- 10. Install the Spring Stud (P/N 07-3271) from the kit in NFSA Mounting Block on the opposite side from the 6-32 1/2" screws. For the Access 2 NFSA use the top hole.
- 11. Attached one end of the Extension Spring (P/N 07-3270) from the kit to the Spring Stud.
- 12. Remove the Z head front right screw on the top.
- 13. Attach the Spring Bracket (P/N 01-3491) from the kit with the short end hanging down with the screw removed from the Z Head. The Spring Bracket should be pointing towards the front of the prober.
- 14. Attach the Extension Spring to the Spring Bracket on the Z Head.
- 15. Attach the NFSA Probe Block to the Z Rail using the two Screws 3-48 x 3/8" (07-3208) from kit.
- 16. Insert the Probe wire into the hole at the bottom of the NFSA Probe Block.

- 17. Move the BNC cable on the back of the Z Head from the Probe BNC to the RF Probe BNC.
- Mount the Wire Clamp on the NFSA Probe Harness (P/N 06-4284) with a 6-32 ¹/₄" screw (P/N 07-3156) (4-40 screw and washer on older units) to the top hole on the back of the Z Head.
- 19. Connect the USB and NFSA Power cables of the NFSA Probe Harness (P/N 06-4284) to the Z Head.
- 20. Connect the NFSA ground (BNC) cable of the NFSA Probe Harness (P/N 06-4284) to the From NFSA Probe BNC on the back of the Z Head.
- 21. Connect the NFSA USB, Power and ground cables of the NFSA Probe Harness (P/N 06-4284) to the NFSA Probe.
- 22. Manually move the NFSA Probe up and down to it extents and make sure the cables move freely.
- 23. Remove the Protective Boot from the NFSA Probe and place it in the NFSA case.

3-4 Connecting a Huntron Tracker to the Huntron Access

Connect the BNC cables included with the Huntron Access to the Huntron Tracker. Connect the COMMON BNC on the Huntron Tracker to the COMMON BNC on the Huntron Access. Connect the CHANNEL A or SIGNAL BNC on the Huntron Tracker to the PROBE BNC on the Huntron Access.

Access with Tracker inside/Access 2 with Tracker inside: If using the built-in Access Tracker connect the Channel A BNC on the Huntron Access to the Probe BNC on the Huntron Access using the supplied 12" BNC cable.

Connect the power cords to the Tracker (as needed) and the Huntron Access.

3-5 Installing PCI Frame Grabber (Access USB/PCI only)

With the computer power turned off, install the card into the computer by positioning it over the PCI slot and pressing it firmly downward. There is no need to set any addresses or interrupts. Secure the camera card to the computer back panel using the available screw.

A co-axial cable is supplied with the Prober. The PCI camera card has four BNC connectors allowing up to 4 cameras to be connected. Connect one end of the co-axial cable to the top BNC connector as shown. Connect the other end to the BNC port on the Prober marked "Camera".



3-6 Connecting the Huntron Access to a PC

Connect the USB cable to the USB port on the Huntron Access. Connect the other end of the USB cable to an available USB port on the computer.

Follow the instructions for installing Huntron Workstation, support software and software drivers listed on the Getting Started document supplied with this system.

SECTION 4 HARDWARE MAINTENANCE

4-1 Rail Lubrication

The rails should be lubricated once a month.



Warning: The linear raceways have to be lubricated using the supplied linear lube (Huntron Part Number 98-0116) which is included in your Tool kit. Do not use with any other lubricant.

Procedure

1. Lubing Y Rail Slide Bearings

Warning: Keep Linear Lube away from the gold encoder tape located on the outside of the left wall. If Linear Lube or dirt get onto encoder tape it can be cleaned with a lint free cloth and alcohol.

- a. Wipe clean the rail surfaces with a lint-free cloth.
- b. Move the Z Head to the center & back.
- c. Apply a ¹/₂" bead of Linear Lube in the grooves of each Y rail. Move front to back 4 times.
- d. Repeat step "b" 3 times.
- e. Wipe down Y rails, especially the ends as the oil cleans out the rail slides.

2. Lubing X Rail Slide Bearings

Warning: Keep Linear Lube away from the gold encoder tape behind the X rail on the top of the encoder plate. If Linear Lube or dirt get onto encoder tape it can be cleaned with a lint free cloth and alcohol.

Wipe clean the rail surfaces with a lint-free cloth.

- a. Move the Z Head to the back & center.
- b. Apply a ¹/₂" bead of Linear Lube in the grooves of each side of the X rail. Move left to right 4 times.
- c. Repeat step "b" 3 times.
- d. Wipe down X rail, especially the ends as the oil cleans out the rail slides.

3. Lubing Z Rail Slide Bearings

- a. Move the Z Head to the front & center.
- b. Pull the Z probe in the full down position.
- c. Wipe clean the rail surfaces with a lint-free cloth.
- d. Apply a ¹/₄" bead of Linear Lube into the grooves of the Z rail towards the top. Move up and down 4 times.
- e. Wipe off Z Probe cleaning off excess Linear Lube.

4-2 Calibration Requirements

There are no user calibration requirements. The unit is factory aligned and does not need calibration.

Removing or loosening screws on the mechanical parts of the Access can affect movement accuracy.

If the unit is not moving accurately, please call Huntron Technical Support for further instructions.

4-3 Color Camera Adjustments

The camera lens on the color camera has a separate focus and aperture adjustment ring. These adjustment rings can be locked via a locking screw. The aperture setting is factory set and will be in the locked position. The setting is shown below. If the camera image appears dark even with maximum light intensity, it may be necessary to adjust the aperture. By using a larger aperture, more light will enter the lens but the depth of field will be smaller. Components at various heights will appear unfocused. The best setting is to have the smaller aperture (i.e. F8 or higher) and some external, bright, evenly distributed light. A small florescent lamp would be sufficient as an additional external light source.



Note: Changing the Focus or Aperture may cause the distance from the center of the probe to the center of the camera to change. Always perform a Camera Offset after making Focus or Aperture adjustments. When performing Camera Offset always have the aperture set to the lowest setting of 1.4 when focusing. You can set this to a higher f-stop (f8 or higher works well) once Camera Offset is complete.

4-4 Probe Tip Camera Adjustments

The camera lens on the Probe Tip camera is rotated to focus the camera. To move the camera position, be sure to loosen the screw on the camera clamp before moving. Once in position re-tighten the screw (not included with NFSA models). Note: The Probe Tip camera is not included on Access Probers manufactured after mid-2016.

4-5 Spring Contact Probes

The Huntron Access uses a spring loaded probe for making contact with a test point. Various probe styles are available depending on the type of components tested. These probes are commonly used in bed-of-nails fixtures and are readily available from a large number of manufacturers. Since the probe fits into a specific receptacle, only specific probe sizes can be used. The receptacle is press-fitted into the probe holder. It is a widely used industry standard size, so finding probes that fit into this receptacle should not be a problem. Manufacturers of these probes and the receptacle specifications are listed at the end of this section.

Generally, quality probes like those supplied are rated at 1,000,000 cycles minimum. The life expectancy depends on proper use and maintenance of the probe. We recommend that you change the test probe at least once a month.

For information about the NFSA Probe spring contact probe / antenna, see the NFSA Probe manual.

Replacing the Probe Tip

Use the needle nose pliers supplied with the Huntron Access tool kit to pull the probe out of the receptacle. It is not necessary to remove the probe holder to do this. Simply grip the probe tip with the pliers and pull straight downward. The probe should come out easily.



Note: Changing the probe may cause the distance from the center of the probe to the center of the camera to change. Always perform a Camera Offset after changing the probe tip.

If the probe tip is broken, follow the steps below:

It is not necessary to disassemble any parts for this operation. The probe tip may break off from the probe holder in such a way that you are unable to remove the entire part with needle nose pliers.

A small drill bit is provided. Simply rotate the drill bit a few revolutions and when you feel some resistance, just pull downward. The rest of the broken tip will come out.



Probe Kit

A probe kit (P/N 98-0126) is supplied with the Huntron Access probers. The Access probers are shipped with a 4 Point Tapered Crown Probe installed. Refer to the datasheet included with the Prober Kit for detailed probe information.

Manufacturers of Contact Spring Probes

Interconnect Devices, Inc. (IDI); part of Smiths Interconnect 5101 Richland Avenue Kansas City, Kansas 66106 Phone: (913) 342-5544 FAX: (913) 342-7043 http://www.idinet.com

QA Technology Company, Inc 110 Towle Farm Road, Hampton, NH 03842, U.S.A Tel: (603) 926-1193 - Fax: (603) 926-8701 http://www.qatech.com

*Probe manufacturer part numbers are subject to change.

4-6 50 Mil Probe Holder

The 50 mil probe holder can be used to replace the 100 mil probe holder when probing fine pitch components.

- 1. Make sure the Access Prober is powered off.
- 2. Manually move the Z Head of the Access to the front center.
- 3. Pull the Z Probe all the way down.
- 4. Remove the Probe wire from the Probe receptacle.*
- 5. Remove the 3-48 3/8" screw (P/N 07-3208) and the 3-48 lock nut (P/N 07-3250) holding the Probe Block to the Z Rail.
- 6. Use the Allen Wrench to push the screw out of the hole.
- 7. Remove the Probe Block from the Z Rail.

*(Units with wires soldered to receptacle follow Instructions below.)

- 8. Mount the 50 mil probe holder (01-1263) using the screw and nut you just removed.
- 9. Plug the wire onto the 50 mil probe receptacle (07-2197).
- 10. Install spring probe (07-2196) into probe receptacle.
- 11. Power on Access Prober.

*Units with wires soldered to probe receptacle

- Remove heat shrink and de-solder wire from receptacle.
- On the new 50 mil probe holder trim the probe receptacle (07-2197) to 0.25".
- Mount 50 mil probe holder (01-1263) Using the screw and nut you just removed.
- Solder wire to probe receptacle.
- Install spring probe (07-2196) into probe receptacle.
- Power on Access Prober.



Probe Styles

The 50 mil probe holder is supplied with one style of probe tip.

11 mil Crown 50 mil Probe

Used for fine pitch surface mount components.

QA Technology part number: 050-PTP2514H (Huntron P/N 07-2196)

Probe Receptacle Specifications

The general specifications for the probe receptacle, which is press fitted into the Huntron Access probe holder, are as follows:

The IDI part number of this receptacle is 100211-007 or R-50C-WW-025 (Huntron P/N 07-2197).

SECTION 5 SUPPORT ACCESSORIES

This section describes the test board support accessories for use with a Huntron Access. These accessories are used in various combinations to hold different types of boards in the Huntron Access. The description of each accessory includes an illustration and some examples of typical uses.

5-1 Board Spacer



Board Spacer for Access USB p/n 98-0111

The part number for the board spacers for a Huntron Access 2 USB and Huntron Access 2 USB with Tracker is 98-0292. These spacers are longer and have 4 slots.



Board Spacers move the test board away from the slotted walls. The Huntron Access can only probe components that are approximately 0.6" (15mm) away from the slotted walls of the Huntron Access.

Board Spacers snap onto and slide along the slotted walls. They allow the probing of components on the edge of boards and the supporting of boards with protruding components.

5-2 Crossbar

The Crossbar is normally used to hold the front side of the test board.



Cross Bar for Access USB P/N 98-0393

The part number for the longer Crossbar for a Huntron Access 2 USB and Huntron Access 2 USB with Tracker is 98-0119.

5-3 Slide Bar

The Slide Bar mounted on a Crossbar holds the left front corner of the Printed Circuit Assembly. The front of a Slide Bar on a Crossbar can hold the test board away from the Crossbar to allow components on the front edge of the board to be reached by the probe tip. Use a Slide Bar and a Slide Bar Extension mounted on a Crossbar to hold the unsupported side of the test board.



Slide Bar P/N 98-0109 supplied with older systems





Slide Bar P/N 98-0685 supplied with adjustable arms

Newer Access Prober systems include modified slide bars that when flipped over can have adjustable arms added. Support pins can be attached to the arms so a PCB can be mounted using mounting holes (see image above). This configuration has the two crossbars secured into the Bottom slot level and the mounted PCB positioned at the Top slot level.
5-4 Slide Bar Extension

The Slide Bar Extension mounted on a Crossbar can hold the unsupported side of the test board. The Slide Bar Extension can also be configured with a Slide Bar for additional support of the side of the test board.



Slide Bar Extension P/N 98-0132

5-5 Extended Slide Bar

A Crossbar in the middle slot underneath the test board with an Extended Slide Bar can give support to the unsupported side of the test board. Also, a Crossbar in the middle slot is the main support for holding a test board in the top slot that protrudes out from the front of the Huntron Access. In this case, use the Crossbar with two Slide Bar Extensions and two Extended Slide Bars. The Extended Slide Bar is no longer included with the Access Prober. Contact Huntron for more information.



Extended Slide Bar P/N 98-0133

This figure shows how to mount a board that is larger than the normal clamping area. By using Slide Bar Extensions and Extended Slide Bars, the effective clamping area increases. While the clamping area will be increased, the probing area will not change. The additional Crossbar and Extended Slide Bar holds the middle of the unsupported edge of the board and prevent the board from flexing while being probed.



When using Extended Slide Bars, the board must be mounted in the top slot of the Huntron Access. The Crossbars (which hold the Slide Bar Extensions and Extended Slide Bars) are then mounted in the middle slot.



This figure shows how to mount either an irregularly shaped board or a long and narrow board. The additional Crossbar and Extended Slide Bar hold the middle of the unsupported edge of the board and prevent the board from flexing while being probed. The Board Spacers allow the Huntron Access to probe components that are mounted within 0.6" (15mm) of the slotted wall edge of the board.



When using the Extended Slide Bar, the board must be mounted in the top slot of the Huntron Access. The additional Crossbar (which holds the Extended Slide Bar) is then mounted in the middle slot.

5-6 PCA SUPPORT KIT

Two blocks are included in the kit. The block can hold three different length pins which are used to prevent large boards from flexing. (PCA Support Kit is included with the Huntron Access 2 Models)

The 3" pin is used for boards mounted in the top slot.



SECTION 6 TESTING PASSIVE COMPONENTS (With Tracker Only)

6-1. Resistors

Exploring how the Access Tracker ranges interact with different resistance values is a good introduction on how basic ASA troubleshooting is applied. This section will briefly familiarize you with Access Tracker basic operation and teach you how resistor signatures relate to both test range and the resistance of the circuit under test. After completing this section, you will know how to:

- Apply test probes across a resistor
- Identify a pure resistive signature
- Analyze and predict resistive signatures

As you go through the following section, make a mental note on the relationship between the Access Tracker's test range parameters: voltage, resistance and frequency. Put the red test lead in the Channel A jack and the black test lead in the Common jack.



Micro Probe Adjustment

Figure 6-1. Huntron MicroProbe Adjustment.

To display the analog signature of a resistor:

- 1. Select the Tracker tab of the Signature pane of the Huntron Workstation Software.
- Select the 50 ohm range by clicking the Resistance dropdown button and selecting 50.
- 3. Place or clip a test lead on the opposite ends of a resistor and observe the signature.

Below are four analog signatures of different resistors, 150, 1.5 k, 15 k and 150 k ohms in each of the four Ranges. Note how the slope or angle of each analog signature changes with each resistor's value.





Figure 6-2. Signatures of Different Resistors in 4 Ranges.

Now that you have an idea of what the signatures of different resistor values look like in different ranges, the next part will give you an idea of what happens when you vary R_s source resistance, V_s source voltage and F_s source frequency of the Access Tracker and how it affects the resistive analog signature.

The Affect of R_S on Resistor Analog Signatures.

Select the 10V, 50Ω and 200Hz. Change the resistance range to 200, 1K and 5K. Observe the signatures for a 150 ohm resistor in the figure below as R_s varies. Note how these resistor signatures respond to changing Access Tracker's internal resistance.



Figure 6-3. Affect of Varying RS on a 150 Ω Resistor Signature

The Affect of V_s on Resistor Analog Signatures.

Select the 10V, 50 Ω and 200Hz. Change the voltage range to 5V, 2V and 500mV.



Figure 6-4. Affect of Varying VS on a 150 Ω Resistor Signature.

Observe that these signatures do not change with the changing voltage. Note that Vs cannot be set above 10V because R_S is set to a value of 50 Ω . This limit on range parameter combinations is a result of the Access Tracker's STAR feature; it protects components from possible excessive power. In order to set V_S to a higher voltage, you must change R_S to a higher value first.

The Affect of F_S on Resistor Analog Signatures.

Select the 10V, 50Ω and 20Hz range. Change the Frequency to 60Hz, 1KHz and 5KHz. Observe the resistor signatures in the following figures do not change as F_s changes.



Figure 6-5. Affect of Varying F_s on a 50 Ω Resistor Signature.

Shorts and Opens, Resistor Faults

Two of the most common faults that occur in electronic components and circuits are shorts and opens. A short circuit is typically a 0 Ω to 10 Ω low resistive path between two points in a component or circuit that normally would have a higher resistance between them. An open circuit is a break between two points in a component or circuit that prevents current from flowing.



Short Open Figure 6-6. Short and Open Signature.

Review

- The signature of a purely resistive circuit is a straight line because the relationship between voltage and current in a purely resistive circuit is linear.
- This straight line signature can vary from
 - completely horizontal (an open)
 - completely vertical (a short)
- As resistance increases
 - current decreases
 - the signature becomes more horizontal
- As the range increases
 - the volts per division of the horizontal axis increases
 - the internal resistance increases
 - the signature becomes more vertical

Applications

- The Access Tracker is a fast and efficient continuity tester, providing real time information.
- The Access Tracker will quickly locate resistor defects, shorts, opens and degradation that other testers cannot find.
- A majority of component failures are resistive in nature. This is important to remember; a component fault may only appear in one range because of the resistive nature of the fault.
- The Access Tracker's ability to determine the approximate fault resistance value greatly enhances the troubleshooting capability if the correct value is known.
- The Access Tracker can be used to adjust a potentiometer in circuit to an approximate operational setting. This application requires a known good board. Adjust each potentiometer on the board under repair to match the settings on a known good operational board. In most cases, the board under repair can now be powered up to an operational state where it can be adjusted to true specifications.

6-2 Capacitors

With a capacitor connected to the Access Tracker, the test signal across it responds quite differently than a resistor. The typical analog signature of a capacitor is an elliptical or circular pattern due to the fact that relationship between the test signal's current and voltage are non linear. The current's waveform is 90 degrees out of phase with respect to the voltage. The diagram below illustrates this basic principle for capacitors.



As the test signal's voltage crosses zero volts and becomes more positive, the current flowing in the circuit is at its maximum and becoming smaller. By the time the voltage has reached its maximum value, the current in the circuit has ceased flowing. As the voltage begins decreasing toward zero, the current begins increasing toward maximum. When the voltage reaches zero, the current is at its maximum value. Similarly, this same pattern follows as the voltage goes negative.

Because the current is at its maximum value when the voltage is at zero, the current leads the voltage. This is called phase shift and in a purely capacitive circuit, this phase shift equals 90°. On the Access Tracker, this analog signature appears as a circular waveform. The actual shape and slope of the elliptical signature depends on the capacitance and impedance value of the component and the test signal's voltage, internal resistance and frequency.

Capacitor Analog Signatures

The goal of this part is to explore some capacitive signatures and to help you understand how capacitor signatures are related to:

- The capacitance (µf) of the circuit under test
- The frequency (F_s) of the test signal
- The voltage (V_s) of the test signal
- The internal resistance (Rs) of the Access Tracker

Plug the red test microprobe in the Channel A jack, and the black test clip lead in the Common jack.

The device to be tested must have all power turned off, and have all high voltage capacitors discharged before connecting the Access Tracker to the device.

Do the following to display the analog signature of a capacitor:

- 1. Select the 10V, 50 Ω and 60Hz range
- 2. Place or clip a test lead on the opposite ends of a capacitor and observe the signature.

Signatures of Capacitors

The figure below shows analog signatures for four different value capacitors, 1000 μ f, 100 μ f, 10 μ f and 1 μ f. Select 10V, 50 Ω and 60Hz.



Figure 6-8. Signatures Of 4 Capacitors In 10V, 50 Ω and 60Hz Range.

Note that as the capacitance values decrease, each signature changes from a vertical elliptical pattern to a horizontal elliptical pattern. In ASA, a large value capacitor has a signature that looks similar to a short circuit. And likewise, a small value capacitor has a signature that's similar to an open circuit.

Affect of Frequency (F_s) on the Signature of a 10 μ F Capacitor Select 10V, 50 Ω and 20Hz. Then select 60Hz, 500Hz and 5KHz.



Figure 6-9. Signatures of A $10\mu F$ Capacitor at Different Frequencies

Note that as the test signal frequency increases, the 10 μ F capacitor's signature changes from a horizontal elliptical pattern to a vertical elliptical pattern. In ASA, a capacitor at a low test frequency has a signature that looks similar to an open circuit. And likewise, the same capacitor at a high frequency has a signature that's similar to a short circuit.

Affect of Frequency (F_s) on the Signature of a 0.1 μ F Capacitor Select 10V, 1K Ω and 20Hz. Then select 60Hz, 500Hz and 5KHz.



Figure 6-10. Signatures of A 0.1 μ F Capacitor at Different Frequencies.

Note that as the test signal frequency increases, each signature changes from a horizontal elliptical pattern to a vertical elliptical pattern. In ASA, a small value capacitor at a low test frequency has a signature that looks similar to a short circuit. And likewise, a small value capacitor at a high test frequency has a signature that's similar to an open circuit. The signature of the 0.1μ F capacitor is similar to the 10 μ F capacitor in shape but not in size due to the differences in their value.

Affect of Voltage (Vs) on the Signature of a 1 μF Capacitor

Select 200mV, 20K Ω and 60Hz. Then select 5V, 15V and 20V.



Figure 6-11. Signatures of A 1 μ F Capacitor at Different Test Signal Voltages.

As V_{S} , the test signal voltage increases from low to high, the signatures did not change.

Affect of Resistance (Rs) on the Signature of a $1\mu\text{F}$ Capacitor

Select 15V, 1K and 60Hz. Then select 5K, 20K and 100K.



Figure 6-12. Signatures of A 1 μ F Capacitor at Different Internal Resistances.

As the Access Tracker's internal resistance R_s decreased, the capacitor's signature changes from a horizontal elliptical pattern to a vertical elliptical pattern. In ASA, a large

internal resistance value results in a capacitor signature that looks similar to an open circuit. And likewise, a small internal resistance value results in a capacitor signature that's similar to a short circuit.

Understanding Capacitor Analog Signatures



Figure 6-13. Access Tracker Core Circuit Block Diagram with a Capacitor.

The Huntron Workstation Software displays the Access Tracker signature as a response to its test signal, an analog signature that represents the relationship between voltage, current and resistance of a component. For circuits that contain capacitors, the effective resistance is called capacitive reactance, X_c. The mathematical formula is:

$$X_{c} = \frac{1}{2\pi fC}$$

X_c is inversely related to both capacitance and frequency. So to review and summarize capacitive analog signatures up to this point:

- Changing capacitance: As the capacitance of a circuit increases, the capacitive reactance X_C decreases. This means that when capacitance increases, the amount of current in the component or circuit will increase. On the Access Tracker, the elliptical signature will become increasingly vertical that implies more current flow.
- Changing frequency F_s : As the frequency of the test signal increases, the capacitive reactance X_c will decrease and the amount of current in the circuit will increase. On the Access Tracker, the elliptical signature will become increasingly vertical that implies more current flow.
- Changing voltage V_s: As the test signal voltage is changed from 200 mV to 20 V, the following occurs:
 - $\quad X_C \, of \, the \, capacitor \, is \, not \, affected$
 - The applied V increases
 - The elliptical signature is not affected
- Changing source resistance R_s : As the resistance is changed from 1 k Ω to 100 k Ω , the following occurs:
 - X_C of the capacitor is not affected

- V_s increases so current decreases proportionately
- The elliptical signature becomes increasingly vertical

Table 3-1 shows the Access Tracker's limits for the minimum and maximum capacitance values it can handle.

Rs	F _s = 20 Hz.	F _s = 5 kHz
100 kΩ	0.01 μF - 1 μF	100 pF - 0.01 μF
10 Ω	12,000 μF - 100 μF	0.1 μF - 100 μF



Capacitor Leakage Failures

One common physical failure in capacitors is dielectric leakage. The dielectric or insulator in a capacitor normally acts as a non-conductor between the capacitor's two plates. A flawed capacitor develops a conductive or leakage path between its two plates. This can be thought of as a resistance in parallel with the capacitance when observing its analog signature. The following examples show what some capacitor leakage problems may look like in the Access Tracker signature display with 50Ω , 10V and 60Hz selected.



 $\label{eq:hormal} \begin{array}{ll} \mbox{Normal Capacitor} & \mbox{Leaky Capacitor} \\ \mbox{Figure 6-15. Signatures of A 100 μF Capacitor with Dielectric Leakage.} \end{array}$

This example only simulates the leakage flaw by adding a 100 Ω resistor in parallel to a 100 μ F capacitor. It shows the signature change from a normal circular ellipse pattern to a sloped and depressed vertical pattern. The signature of a real capacitive leakage would be quite similar to this example.

Another example of capacitive leakage is shown for a 10 μ F capacitor.



Normal Capacitor Leaky Capacitor

Figure 6-16. Signatures of A 10 μ F Capacitor with Dielectric Leakage at 10V, 500 Ω , 60Hz Again, this example only simulates the leakage flaw by adding a 68 Ω resistor in parallel to a 10 μ F capacitor. It shows the signature change from a normal circular ellipse pattern to a sloped and depressed vertical pattern. The signature of a real capacitive leakage would be quite similar to this example.

As you can see from the two previous examples, adding resistance in parallel to a capacitor distorts the normal signature with a diagonal bend to it. This is our first look at a composite signature, the kind of signature the Access Tracker displays when there are several components connected together in a circuit.

Review

- Capacitors have elliptical signatures due to the current and voltage phase shift.
- As the test signal's frequency increases, the capacitor's signature becomes more vertical due to decreasing X_c of the component.
- Capacitors with leakage flaws have their ellipses tilted diagonally due to an internal resistance in parallel with the capacitance.

Applications

- The Access Tracker can locate defective capacitors in or out of circuit. The ranges cover 100 pF to 12,000 $\mu F.$
- When analyzing a capacitor's signature, adjust the Access Tracker's R_s and F_s for the most pronounced ellipse.
- The test signal frequency F_s, can be changed to enhance a composite signature by emphasizing or de-emphasizing the capacitance.
- Besides resistance, faulty capacitor signatures often exhibit other irregularities such as non-symmetry, broken or distorted ellipse and saw-toothed shapes that can be seen in the signature display.

6-3 Inductors

Inductors, like capacitors, have elliptical analog signatures and respond to Access Tracker's test signal non-linearly. Also like capacitors, an inductor's reactance (resistance to an AC test signal) is dependent on the test signal's frequency. Because of the way they are constructed using wire with some amount of resistance in it, it is hard to find a pure inductance. An inductor's analog signature will usually be an elliptical pattern with some slope or tilt to it due to the resistance of the coil wire.

Inductor Analog Signature

The goal of this section is to explore some inductive signatures and to help you understand how inductor signatures are related to:

- The inductance (L µH) of the circuit under test
- The frequency (F_s) of the test signal
- The voltage (V_s) of the test signal
- The internal resistance (R_s) of the Access Tracker

Plug the red test microprobe in the Channel A jack, and the black test clip lead in the Common jack.

Do the following to display the analog signature of an inductor:

- 1. Select 50Ω , 10V and 60Hz range (LOW Range)
- 2. Place or clip each test lead on the opposite ends of an inductor and observe the signature in the Access Tracker signature display.

Signatures of Inductors in 50 Ω , 10V and 2KHz

The figure below shows analog signatures for four different value inductors, 12,000 μ H, 1200 μ H and 12 μ H. Select 10V, 50 Ω , 2KHz.



Figure 6-17. Signatures of 4 Inductors at 10 V, 50 Ω , 2KHz.

Note that as the inductance values decrease, each signature changes from a horizontal elliptical pattern to a vertical elliptical pattern. In ASA, a large value inductor has a signature that looks similar to an open circuit. And likewise, a small value inductor has a signature that's similar to a short circuit.

Affect of Frequency (F_s) on Inductor Signatures

Select 10V, 50 Ω , 60Hz. Then Select 1KHz and 5KHz.





Note that the signature changes from a vertical position to a horizontal position as the frequency increases. This means the resistance of an inductor increases as frequency increases.

Affect of Voltage (Vs) on Inductor Signatures Select 200mV, 50Ω , 60Hz. Then Select 5V and 10V.



Note that the signature does not change at the three test signal voltages. This means that the inductor's resistance is not affected by changes in the test voltage.

Affect of Internal Resistance (R_s) on Inductor Signatures Select 2V, 10 Ω , 60Hz. Then Select 50 Ω and 200 Ω .





Note that the signature changes from a horizontal to a vertical position as the Access Tracker's internal resistance R_s increases. This means the inductor's resistance can be analyzed by matching it with the Access Tracker's test signal resistance.

Understanding Inductive Signatures



Figure 6-21. Access Tracker Core Circuit Block Diagram with an Inductor.

The Access Tracker's block diagram shows an inductor between the test terminals. The current is represented by the vertical axis and is derived as a series current that flows through Access Tracker's internal resistance, R_S. The voltage is represented by the horizontal axis and is derived as a voltage across the inductor.

The formula for the reactance X_L of an inductor is:

$X_L = 2\pi fL$

As the test signal frequency increases, the inductive reactance X_L becomes larger. As a result, the inductor's analog signature will change from a rounder elliptical to a flatter resistive type pattern. The size and shape of the ellipse depend on the inductor value, test signal frequency, and the selected resistance R_S .

Since inductors in reality are not pure inductors, the elliptical signatures they form on the Access Tracker display are usually distorted. Inductors constructed with a ferrite core

make the inductive characteristics different from those constructed without. The Access Tracker responds with a unique analog signature for each inductor type.

Rs	Fs = 20 Hz.	Fs = 5 kHz
100 kΩ	100H — 1000H	50mH – 1000mH
10 Ω	1H – 100H	1uH – 10mH

Table 6-2. Access Tracker Minimum and Maximum Inductor Values

Review

- Inductors display elliptical signatures similar to capacitors. Since the inductor also exhibits resistance, due to its construction, the ellipse may be distorted.
- As the Access Tracker test signal's frequency is increased, the ellipse signature becomes flatter. This response is opposite to that of a capacitor.
- As the Access Tracker internal resistance R_s increases, an inductor's signature becomes more vertical (like the capacitor signature).
- When an inductor has a ferrite core, its signature distorts from a non-ferrite inductor's ellipse.

Applications

- The Access Tracker is excellent for troubleshooting inductors. It can reveal shorted or open windings in large variety of inductive components.
- Components that are inductors or have inductive characteristics can be found in many real world applications. For example, some of these are power transformers, relays, solenoids; fly backs, speakers, magnetic sensors, stepping motors and motor windings.
- The best technique for testing inductors is the comparison of a known good component's signature to a suspect component. For example, a motor armature has typically numerous windings so every winding should have a similar analog signature. This fact is true whether it's from an elevator or a tape deck. The armature of a DC motor can be tested by simply connecting to the motor brush leads and then adjusting the test range for the most pronounced or descriptive signature. Slowly turn the armature. Observe the Access Tracker's signature display. This test will check continuity, the inductance and the condition of each brush contact without disassembling the motor.
- A computer switching power supply contains inductors. For example, a computer is reported "dead". To make a quick diagnosis of the possible problem first make sure the computer is disconnected from AC power. Then connect the red and black test probes across the prongs on the AC line cord going to the computer. Turn the computer power switch to the on position. If there is a response on the Access Tracker signature display, adjust the test range for the most pronounced inductive signature. Flick the power switch off and on and watch for noisy switch contacts. If there is no response, start by checking each component up to the primary winding of the transformer. With this technique, we have just verified the AC cord, the AC noise filter, the fuse, the power switch and the primary winding of the transformer, without removing the cover from the computer.

- Another simple test for a speaker or microphone is to apply the Access Tracker signal in $V_S = 10 \text{ V}$, $R_S = 50 \Omega$, $F_S = 60$ Hz range to the device input leads and listen for the 60 Hz tone or audible hum.
- To test solenoids, connect the test probes to the coil leads and manually move the plunger or activator in and out while observing if its signature changes.

6-4 Electromechanical Switching Components

Switches are electrical devices that either stop or allow current to flow in a circuit. They are either in an on or off state. Switching devices come in all types and sizes. There are simple mechanical switches, relays, optical switches, and many kinds of semiconductor switches. They are different because each uses a different kind of stimulus to turn them on or off. Because there are so many kinds of switching devices, there is no single testing procedure that will test them all completely. With the Access Tracker, the test signal can be setup so that the switch's analog signature will verify its switching function. The goal of this section is to develop a test strategy using ASA to test the switching function. This is not a complete test, but it will be enough to determine whether or not the device is functioning as a switch.

Manually Operated Mechanical Switches

A mechanical switch has two states: it is either open or closed. When open, no current can flow; when closed, it acts as a short and allows current to flow. The Access Tracker can test the switching function of mechanically activated switches easily. Unlike the DVM that samples and gives a continuity measurement, the Access Tracker displays real time activity so if a switch has noisy, resistive or intermittent operation, its analog signature on Access Tracker's display will reflect these conditions.

Plug the red test microprobe in the Channel A jack, and the black test clip lead in the Common jack.

Do the following to display the analog signature of a mechanical switch:

- 1. Select the Vs = 10 V, Rs = 50 Ω , Fs = 60Hz range button.
- 2. Place or clip each test lead to the switch leads and observe its signature on the Access Tracker signature display.
- 3. Turn the switch to its on or off position.



Figure 6-23. Signatures of a Pressed Keyboard Pushbutton Conductive Elastomer Switch. Note that as the ranges change from $20K\Omega$ to $1K\Omega$ to 50Ω , the signature tilts away from the vertical. This characteristic is similar to other components with internal resistance.

Review

• The switch has internal resistance.

• As the test signal's voltage decreases with each range change, the volts per division of the horizontal axis also decreases so that its analog signature becomes more pronounced. This is caused by the small voltage drop across the switch's internal resistance.

Electromechanical Relays

A relay is a switch that's activated by an electrical control input. The relay consists of switch contacts, magnets and an electromagnetic coil. The Access Tracker can test the coil part of the relay by looking at its inductive analog signature. **RELAY COIL TEST** Do the following:

- 1. Select the V_s = 10V, $R_s = 50\Omega$, $F_s = 1$ KHz range.
- 2. Connect the black test lead from Access Tracker's Common jack to one side the relay coil (normally, the minus lead).
- 3. Connect the red test lead from Access Tracker's Signal jack to the other side of the relay coil (normally, the plus lead).





Figure 6-24. Signatures of a Magnetic Reed Relay Coil at 1KHz.

Note the characteristic inductive oval at 3 resistances. When applying Access Tracker's test signal to the coil, there may be an audible ringing sound generated from the relay under test from the switch contacts being excited.

Review

- The Access Tracker can test switches in real time. This makes an excellent test for micro switches, power switches, control switches, pressure and heat sensor switches.
- As the mechanical switch closes, watch for erratic or discontinuous signature. Switch bounce will display as multiple closure signatures. Resistive contacts will display a resistive signature at 50Ω.

SECTION 7 TESTING DISCRETE SEMICONDUCTORS (With Tracker Only)

7-1. Diodes

The most basic type of solid state semiconductor component is the diode. Diodes are formed by creating a junction between p-type and n-type semiconductor material. The PN junction gives diodes and semiconductor components polarity characteristics that allow them to conduct current when an external voltage is applied. They conduct current in one direction, but not in the other. Current flows in a diode when the positive terminal (anode) is made more positive than the negative terminal (cathode). Figure 5-1 shows how the diode symbol indicates the polarity of the diode.



Figure 7-1. Diode and Schematic Symbol.

Diode Analog Signatures

Diode signatures demonstrate the fundamental operation of a semiconductor junction. There is a threshold or forward voltage V_F (about 0.6V for a silicon diode) at which the diode begins to conduct current. The diode acts as an open circuit and no current flows as long as the voltage differential between the anode and cathode is below that threshold. As the anode to cathode voltage becomes more positive, the diode will begin to conduct current. Once current begins to flow in the diode, very small increases in anode voltage will cause very large increases in current. In analog signature analysis, this is called the "knee" effect in which is characteristic of a good semiconductor junction.



Figure 7-2. Access Tracker Core Circuit Block Diagram with a Diode.

You can see this "knee" signature on some diodes in the next section.

Do the following to display the analog signature of a diode:

- 1. Select 50 Ω , 10V and 60Hz.
- 2. Place or clip the red test lead from the Access Tracker's Channel A jack to anode lead of the diode.
- 3. Place or clip the black test lead from the Access Tracker's Common jack to anode lead of the diode.



Figure 7-3. Signatures of a 1N914 type Silicon Diode at 50Ω and 60Hz.

The diode signatures are similar to each other. In the 50 Ohm range, the test signal voltage is $10 V_P$. Each horizontal division on the display equals approximately 2.5 V. In this range the diode's signature shows that its threshold or forward voltage is approximately 0.6 Volts. By lowering the test voltage to 3 V with the encoder, the 0.6 volt threshold is clearly visible for easier analysis.

Affects of Frequency (F_s) on Diode Signatures

With the 3V, 50Ω selected and the test signal frequency of 60 Hz, the signature of the diode is shown on the left figure below. Changing only the test signal frequency to 5 kHz displays the signature on the right. At F_S = 5 kHz, the diode's signature has slight circular loop added to it. This loop in the signature is due to a physical characteristic of diodes called junction capacitance.



Figure 7-4. Signature of A 1N914 Diode at Different Frequencies at 3V and 50Ω .

Affects of Internal Resistance (Rs) on Diode Signatures

Changing Access Tracker's internal resistance R_s moves the vertical knee portion of the diode's analog signature. As R_s increases, the knee of the signature moves inward toward the origin. R_s controls the current that's flowing through the diode so the forward diode voltage changes in response to the current change.



 $R_s = 54\Omega$ $R_s = 100K\Omega$ Figure 7-5. Signature of A 1N914 Diode at Different Resistances at 3V and 60Hz.

Composite Diode Signatures

A composite analog signature is a combination of several components connected together in an electronic circuit. Up to this point, we have been showing you what the basic component signatures look like out of circuit. In the real world of electronics troubleshooting, components are connected together in a circuit and when testing with ASA, the signatures are a composite that may appear quite complex. However, with knowledge of ASA fundamentals and experience you will find that even the most complex looking signatures can be analyzed quickly and efficiently.

This section will introduce you to some examples of composite diode signatures.



Figure 7-7. Composite Model of a Diode and Capacitor in Parallel.



 $V_s = 10 V$, $F_s = 20 Hz$ $V_s = 10 V$, $F_s = 1 KHz$ $V_s = 200 mV$, $F_s = 1 KHz$ Figure 7-8. Composite Signature - 1N914 Diode and 1µF Capacitor in Parallel.

The signature on the left shows only the diode signature because the test signal frequency is set below any visible contribution due the capacitive reactance. The composite signature in the center consists of the distinctive loop of the capacitor and the "knee" pattern of the diode. The signature on the right shows only the capacitor signature because the test signal voltage is below the diode's turn on level. When multiple components are connected together, it's important to realize that the Access Tracker has the ability to selectively display the signature of a single component.



Figure 7-9. Composite Model of a Diode and Resistor in Parallel.



Figure 7-10. Composite Signature - 1N914 Diode and $1.5K\Omega$ Resistor in Parallel.

The signature on the left shows only the diode signature because the test signal resistance is set below any visible contribution due the 1.5 k Ω resistor. The composite signature in the center consists of the distinctive slope of the resistor and the "knee" pattern of the diode. The signature on the right shows only the resistor signature because the test signal voltage is below the diode's turn on level. Again, when multiple components are connected together, it's important to realize that the Access Tracker has the ability to selectively display the signature of a single component.

Diode Failures

Diodes can fail in a number of ways, and each type of failure will cause the signature to change. The defective diodes often appear as open and short signatures. Two other types of flaws are internal resistance and leakage.



Figure 7-11. Defective Diode Model with a Small Series Resistor.



54 Ω , 10V 1K Ω , 15V 20K Ω , 20V Figure 7-12. Defective Diode Signature with a 50 Ω Series Resistor.

The LOW range shows that there is a resistive component to the signature when the diode is conducting. This is the result of a defect in the diode's internal PN junction. The resistance is visible only in LOW range because the voltage drop across it is small. In the other two ranges, the resistance is masked due to the internal resistances being too large to show such a small voltage drop.





Figure 7-13. Defective Diode Model with an Internal Leakage Resistance.



 $50\Omega, 10V 1K\Omega, 15V 20K\Omega, 20V$ Figure 7-14. Signature of a 1N914Diode with Internal Leakage (10K Ω in Parallel).

Notice that in the 50Ω range, there does not seem to be a problem. In both medium ranges, you can see the diode conducting when it should be acting like an open. This is called leakage. The diode acts like a diode when it is forward biased. When reverse biased, the diode acts like a resistor when it should be acting as an open.

Zener Diodes

Normal switching and signal diodes conduct when forward biased only. When reverse biased, they act as opens unless they are operated outside design limits. If this condition occurs then so much voltage is applied that they break down and can no longer prevent current flow.

A Zener diode is a different type of diode and is designed for operation when reverse biased (diode's cathode connected to positive and anode to negative), but under carefully controlled conditions. When the Zener diode is forward biased (diode's cathode connected to negative and anode connected to positive), they act as regular diodes and begin to conduct at approximately 0.6V.

When reverse biased, they act as an open until the applied voltage reaches their specified Zener voltage, at which time the Zener diode begins to conduct current. Even if the reverse voltage is increased, the voltage across the Zener remains constant. It is this feature of Zener diodes that allows them to be used as voltage regulators and references. Because they conduct in both directions, the Zener diode's analog signature has two knees, one at 0.6V and the other at the Zener voltage of the diode. In ASA terminology, this two knee signature is known as the classic "chair" pattern that is common in many solid state semiconductor components.



Figure 7-15. Access Tracker Core Circuit Block Diagram with a Zener Diode.



Figure 7-16. Single Zener Diode and 2 Zener Diodes in Series.





Since each horizontal division on the Signature graticule (in 20V range) is approximately 5 Volts, from the signature on the left you can estimate that this is about a 9 volt Zener diode. The signature at the right is the signature of two Zener diodes connected in series. The Zener voltage (V_Z) of this circuit is the sum V_Z of each of the separate diodes. The signature shows this voltage to be approximately 18 Volts.

Review

- Diodes conduct current in one direction (forward biased) and not the other. The diode's analog signature displays this characteristic as the "knee" effect or pattern.
- Diodes have polarity, an anode and a cathode.
- Diode defects, other than opens and shorts, are usually resistive.
- A diode in series or parallel with a resistor or capacitor will create a composite signature displaying both characteristics. The Access Tracker makes it easier to separate these characteristics from composite signatures using the three parameters Fs, Rs and Vs.
- Zener diodes are special diodes that conduct when reverse biased at a specific voltage.

Applications

- Diode damage or degradation can appear as a loss of sharpness or rounding in the "knee".
- While faulty diodes display resistive current and voltage legs, they are usually nonlinear or curved.
- The polarity of an unmarked diode can be determined by the orientation of the display with a known diode.
- The Access Tracker can be used to identify an unknown Zener diode. If the Zener diode is damaged, locate a good one, possibly on another board or in the same circuit and use the Access Tracker to approximate the voltage.
- Look for the Zener effect when checking voltage regulators such as the 7805 type. This can help determine an unknown or faulty device.
- The Access Tracker can be used to test and determine the four pin connections on a bridge rectifier, (AC1, AC2, + and -).

7-2 Transistors

A bipolar transistor is a three layer device. There are two basic types. A PNP transistor has a layer of n-type silicon material sandwiched between two layers of p-type material. An NPN transistor has a layer of p-type silicon material sandwiched between two layers of n-type material. Figure 5-20 shows the relationship between type of material and circuit symbol for a PNP and an NPN transistor.



Use of this instrument may alter the current gain (h_{FE} or ß) of a bipolar transistor whenever the emitter is tested. Either the base-emitter or collector-emitter test circuits satisfy this criterion. While heating of the device due to the current produced by the instrument may cause a temporary change in h_{FE} (most noticeable in the low range), a permanent shift in h_{FE} may occur whenever the base-emitter junction is forced into reverse breakdown (~6-20 Volts). If the voltage is above 6 Volts, then the magnitude of the shift depends on the duration of the test and the resistance selected. Reducing the voltage to 5 Volts or less will avoid this problem.

Most bipolar transistor circuit designers take into account a wide variation in h_{FE} as a normal occurrence and design the related circuitry to function properly over the expected range of h_{FE} . The effects mentioned above are for the most part much smaller than the normal device variation so that the use of this instrument will have no effect on the functionality of good devices and can fulfill its intended purpose of a means to locate faulty components. However, some circuits may depend on the h_{FE} of the particular part in use, e.g. instrumentation that is calibrated to certain h_{FE} value or precision differential amplifiers with matched transistors. In such instances, this instrument should not be used as its use may cause the h_{FE} to shift outside the limited range where calibration can correct for any change.

Suggestions to minimize effects on bipolar transistors:

- 1. Use 5 Volts or less for testing the base-emitter or collector-emitter.
- 2. If using 6 Volts or greater, then keep the duration of the test as short as possible.
- 3. Identify the base, emitter and collector pins of the device and then test the collector-base junction to determine whether it is an NPN or PNP. Since the emitter is not tested there will be no effect on h_{FE} regardless of the selected voltage.

Bipolar Transistor Signatures

In order to better understand the signatures that transistors create on the Access Tracker, we can model these devices in terms of equivalent diode circuits. These are shown in figure 5-21. These figures show that the collector-based junction analog signature looks similar to a diode signature, and the emitter-base junction signature looks similar to a Zener diode signature. Because we have already seen the signatures of these two types of junctions when we tested diodes, they should be familiar to you.



Figure 7-19. NPN And PNP Bipolar Transistor Equivalent Circuits

Bipolar Transistor Base-Collector Signatures

Do the following to display the analog signatures of a bipolar transistor:

- 1. Select the 1K Ω and 15V.
- 2. Place or clip the red test lead from the Access Tracker's Channel A jack to collector lead of the transistor.
- 3. Place or clip the black test lead from the Access Tracker's Common jack to base lead of the transistor.


Figure 7-20. Signatures of a Diode and Collector-Base of Transistors at $1K\Omega$ and 15V.

Notice that the collector-base signature of a NPN transistor is identical to the signature of diode. The collector-base signature of a PNP transistor, which has opposite polarity from a NPN, looks similar to a diode with its polarity reversed. These are the signatures we expected from our circuit modeling. We can do the same kind of comparison with the emitter-base circuits.



Figure 4-21. Signatures of a Diode and Emitter-Base of Transistors at $1K\Omega$ and 15V.

We can see that the base-emitter signature of the NPN transistor is nearly identical to the signature of the Zener diode. The emitter-base signature of a PNP transistor is also nearly identical but opposite in polarity to the Zener diode.



PNP Transistor - 2N3906 NPN Transistor - PN2222A Figure 7-22. Signatures of the Collector-Emitter of Transistors at $1K\Omega$ and 15V.

You can see that the collector-emitter signature of a PNP transistor looks like a forward biased diode with the knee at approximately +7 Volts. The collector-emitter signature of a NPN transistor looks similar to a reverse biased diode with the knee at approximately - 7 Volts.

All bipolar junction transistors have essentially the same looking signatures.

Identifying Unknown Transistors

Sometimes, we need to identify unknown transistors. We may need to replace one in a circuit for which we do not have a schematic. The Access Tracker makes this a relatively simple procedure because each type of junction has a characteristic signature. This makes it possible to identify each of the terminals and the polarity of the transistor. Do the following:

- 1. Select 20V, 20K Ω and 60Hz.
- 2. Probe pin 1 with the red probe and pin 2 with the black probe.
- 3. Identify the signature.



Figure 7-23. Signature of Pins 1 And 2 Of an Unknown Transistor.

4. This looks like a collector-base signature. What you do not know yet, is which pin is the collector and which pin is the base?

- 5. Probe pin 3 with the red probe and pin 2 with the black probe.
- 6. Identify the signature.
- 7. This looks like a collector-emitter signature.



Figure 7-24. Signature of Pins 3 and 2 of an Unknown Transistor.

8. Now that you know that pin 2 of the unknown transistor is the collector. Place the black probe to the base on pin 1 and move the red probe to the emitter on pin 3. A base to emitter signature will be displayed. This transistor is a NPN type since the base-emitter signature matches a NPN transistor.



Figure 7-25. Signature of Pins 1 And 3 Of an Unknown Transistor.

Darlington Bipolar Transistor Signatures

The Darlington transistor is basically two transistors paired together in a special configuration. The emitter of the first transistor is connected to the base of the second transistor. The collectors of both transistors are connected together. The base of the first transistor serves as the external base lead and the emitter of the second transistor serves as the external emitter lead. A block diagram of a Darlington transistor and its analog signature are shown in the following figures.





Figure 7-27. Signature of a Darlington Transistor, TIP112 NPN Type at 20V and $20K\Omega$.

Note that the B-E junction has a sloped leg bend in its signature caused by internal resistors R1 and R2.

Review

- A PNP bipolar transistor consists of a layer of N-type silicon sandwiched between two layers of P-type silicon.
- A NPN bipolar transistor consists of a layer of P-type silicon sandwiched between two layers of N-type silicon.
- To test a transistor, the base-emitter (B-E), collector-base (C-B) and collector-emitter (C-E) junctions all need to be examined.
- The transistor signature resembles the diode signatures previously examined. They have polarity and may exhibit the Zener effect.

Applications

- Transistors will display the same type of faulty signature as diodes, with a rounded "knee" and non-linear or resistive current and voltage legs.
- The Access Tracker can be used to determine the type of transistor; bipolar, Darlington, FET, etc.
- The Access Tracker can be used to identify the polarity of a transistor (PNP or NPN).
- The Access Tracker can be used to determine the base, collector and emitter on an unknown transistor.
- The Access Tracker can be used to match the gain (beta) of two transistors.
- The above techniques of identification are invaluable when repairing foreign electronics and systems without schematics.

7-3 Solid State Switching Components

Optical Switches

There are two types of optical switches: phototransistors and opto-couplers. Phototransistors can be used in two modes depending on the application. It can be used as either a light activated transistor or as a light activated diode. In either mode, light is used to turn it on and allow current to flow.

An opto-coupler consists of a light emitting diode and a phototransistor in the same package. They are electrically isolated. When the diode is turned on by an external signal, it radiates light. This light falls on the phototransistor base junction that results in the device turning on.

Phototransistor



Figure 7-28. Phototransistor Schematic Diagram.

Do the following to display the analog signature of a phototransistor:

- 1. Select the 1K Ω and 15V.
- 2. Place or clip the red test lead from the Access Tracker's Channel A jack to collector lead of the component.
- 3. Place or clip the black test lead from the Access Tracker's Common jack to emitter lead of the component.





Figure 7-29. Signatures of a NPN C-E Junction Phototransistor at 15V and $1K\Omega$.

The phototransistor's signature is similar to a diode's signature in reverse breakdown mode when not activated by light and as a short signature when activated by a bright external light.

SCRs and TRIACs

A SCR and TRIAC are semiconductor components that are used in switching applications. A SCR (silicon controlled rectifier) is used for DC switching circuits. A TRIAC is used for AC switching circuits. This section will demonstrate how to dynamically test these components.

Silicon Controlled Rectifiers (SCRs)

The SCR is a switching semiconductor device that conducts positive current only. Its symbol and equivalent circuit can be seen below. When the gate (G), is at the same voltage level as the cathode (K), the SCR acts like an open. When the gate (G), is forced more positive than the cathode (K), positive current flows between the anode (A) and the cathode (K).



Figure 7-30. Diagram of a Silicon Controlled Rectifier.

Do the following to display the analog signature of a SCR:

- 1. Select the 20V, 20K Ω and 60Hz.
- Place or clip the red test probe from the Access Tracker's Channel A jack to gate lead (G) of the component.
- 3. Observe the gate-anode signature of the SCR.
- 4. Move the black test probe from the SCRs anode lead to cathode lead (K) of the component.
- 5. Observe the gate-cathode signature of the SCR.

- 6. Place the red test probe to the SCRs anode lead and the black test probe to the SCRs cathode lead.
- 7. Observe the SCRs anode-gate signature.



Gate-AnodeGate-CathodeAnode-CathodeFigure 7-31. Signatures of A SCR - C106B Type at 20V and 20KΩ.

Review

- Solid state photosensitive switch components are turned on by light.
- SCRs and TRIACs are solid state switches that are turned on by a control input pin called a gate. SCRs conduct current in one direction while TRIACs conduct current in both directions.

Applications

• The SCR and TRIAC can also be a problem to troubleshoot. They may be used to switch large currents. Quite often these components are susceptible to degradation and eventual failure. The ProTrack can easily show these failure.

SECTION 8 TESTING INTEGRATED CIRCUITS (With Tracker Only)

8-1 Digital Integrated Circuits

Digital integrated circuit (IC) chips are made from transistors on a common substrate. Their analog signatures are typically variations of the discrete diode and transistor signatures. Most logic ICs, contain multiple circuits in one chip. These chips can have pins from 14 to over 200, although quite often many pins share quite similar signatures. This can make troubleshooting easier by giving us an easy-to-find signature to use as a comparison. In this section, it is important to understand how the Access Tracker and ASA respond to these circuits.

Integrated Circuit Failures

A functioning IC may stop working for a number of reasons. Some of the most common causes of IC failures are:

- EOS Electrical Over Stress. The IC's maximum electrical specifications have been exceeded. This condition may result in the IC developing internal shorts and opens.
- ESD Electrostatic Discharge. Repeated exposure may cause internal resistance to develop in the IC junctions. This internal resistance may vary from 5 k Ω to 25 k Ω with a typical value of 20 k Ω . ESD exposure can cause internal flaws such as resistance, opens and shorts.
- Dendrites A process flaw, that results in particles growing between conductors on a substrate causing shorts.
- Ionic Contamination introduced at the time of manufacturing that develops into leakage between substrate channels. This causes 5 k Ω to 25 k Ω of resistance.
- Purple Plague Destructive interaction between gold and aluminum metal layers. Junction connections become very brittle and may cause internal opens.

• Corrosion or Electromigration - Another process flaw in which aluminum metallization causes pinholes, corrosion and resistance. This will create opens and resistance.

Digital Integrated Circuit Signatures

Before we examine the analog signatures of an IC, let's study the block diagram of a 74LS245 octal bi-directional bus buffer to introduce some basic concepts. This IC is a member of the low power Schottky transistor-transistor logic family (LSTTL). Examine the block diagram for this chip below. You will see that there are only four different kinds of circuits on this chip.



Figure 8-1. Digital IC 74LS245 Block Diagram.

- Circuit 1 Pins 2 through 9 and 11 through 18 are all the same function. Each pin is connected to both an input and an output of a buffer.
- Circuit 2 Pins 1 and 19, although they have different names, are both enables and are inputs to AND gates.
- Circuit 3 Power supply ground input, pin 10.
- Circuit 4 Power supply V_{CC} input, pin 20.

Each circuit type will produce a different analog signature. Because there are only four types of circuits on the chip, there will be only four unique analog signatures when out of circuit.

Signatures of a Digital IC

Do the following to display the analog signatures of a digital IC (out of circuit):

- 1. Select the 20V, $10K\Omega$, 200Hz Range.
- 2. Place or clip the black test lead from the Access Tracker's Common jack to the IC's ground pin. For this example, the ground pin of the 74LS245 is pin 10.
- Use the red test lead from the Access Tracker's Channel A jack. Probe each pin of the IC and view its signature on Access Tracker's signature display. For this example, pins 2 to 9 and 11 to 18 are all buffer circuits so they will have identical signatures. (Note: This is only for ICs out of circuit.)

- 4. Use the red test lead from the Access Tracker's Signal jack. Probe the enable input pins of the IC and view their signatures on the signature display. For this example, the enable pins of the 74LS245 are pin 1 and 19 and will have the same signatures. (Note: This is only for ICs out of circuit.)
- 5. Change the range to 10V, 100 Ω , 200Hz. Use the red test lead from the Access Tracker's Signal jack. Probe the power supply V_{CC} input pin and view its signature on the signature display. For this example, the V_{CC} pin of the 74LS245 is pin 20.



Buffer pinsEnable pins V_{cc} Power pir20V, 10K Ω , 200Hz20V, 10K Ω , 200Hz10V, 100 Ω , 200Hz.Figure 8-2. Signatures of a Digital IC, 74LS245. Ground Pin to Test Common

Compare these signatures with other signatures of discrete components such as transistors and diodes. Note that there are quite a few similarities here.

Signatures of Logic IC Families

There are a wide variety of logic circuit families. Each has its special functions, advantages and limitations. They range from TTL and its variations (F, LS, S, etc.), emitter-coupled logic (ECL), to the complementary metal oxide semiconductor (CMOS) and its variations (C, HC, HCT, VC, etc.).

Comparing Two TTL Families

Although the logic function is the same, there are differences in the circuitry of each logic family. These differences can be readily seen in their signatures using the Access Tracker.

We will illustrate these concepts with the following example of two hex inverters, a 7404 and a 74LS04 from different logic families. From the logic diagram below, you can see that they have the same logic functions and pin order. The difference is that the LS chip uses Schottky transistors in its internal construction for increased performance and reduced power consumption. Note that there are only four types of circuit connections and therefore only four signatures on this chip: inverter inputs, inverter outputs, V_{CC} and ground.



Figure 8-3. Diagram of 7404 & 74LS04.



Note the differences between the two logic families. They have the same logic function but different construction, therefore different signatures. To test one of these chips

without another reference chip available just compare each input's signature with the other five inputs. Similarly, compare each output's signature with the other five outputs.

CMOS Logic Family

CMOS circuits are constructed differently than TTL circuits. The inputs to CMOS transistors are capacitive due to the use of field-effect transistors (FET) instead of bipolar transistors used in TTL.

In this example, we will choose a 74HC14 Schmidt Trigger Hex Inverter. The HC designation means that it's a member of the high-speed CMOS logic family. From the block diagram of this part, you can see that it has only four different circuit functions. They are inverter input, inverter output, power supply V_{CC} input and power supply ground.



Figure 8-6. 74HC14 Block Diagram.

Do the following to display the analog signatures of a digital IC:

- 1. Select the 50 Ω and 10V, 60 Hz range.
- 2. Place or clip the black test lead from the Access Tracker's Common jack to the IC's ground pin. For this example, the ground pin of the 74HC14 is pin 7.
- 3. Use the red test lead from the Access Tracker's Signal jack and probe each pin of the IC. For this example, pins 1, 3, 5, 9, 11 and 13 are all input buffer circuits so they will have identical signatures. (Note: This is only for ICs out of circuit.)
- 4. Similarly, use the red test lead and probe the output buffer pins 2, 4, 6, 8, 10 and 12. These pins will have the same signatures. (Note: This is only for ICs out of circuit.)
- 5. Use the red test lead from the Access Tracker's Signal jack and probe the power supply V_{CC} input pin. For this example, the V_{CC} pin of the 74HC14 is pin 14.



Figure 8-7. Signatures of A 74HC14 CMOS Hex Inverter.

CMOS Components and Test Frequency (Fs)

CMOS logic circuits inherently have a significant amount of internal capacitance. This junction capacitance is visible in the CMOS signatures when using the Access Tracker. Capacitance in CMOS circuitry may be emphasized or de-emphasized by changing the frequency of the test signal.



10V, $1K\Omega$ Range Figure 8-8. Signatures of A 74HC14 Input Pin At Different Frequencies.

Troubleshooting Digital Logic ICs

Comparison testing is a very powerful and effective test strategy when troubleshooting digital logic using ASA. The Access Tracker's Alt feature makes this technique quick and simple. Instead of having to remember the specific signatures of a good component, all that's needed is to have a reference component or board next to the one that's suspect. This section gave many examples of signatures from TTL, Schottky TTL and CMOS logic families. Although from first inspection, these signatures appear to be complex, remember that each of the ICs in the examples had really only four unique signatures (buffer input, buffer output, power supply VCC and power supply ground). We can use this characteristic to develop an effective model for troubleshooting digital logic chips.

- 1. Select the 50 Ω , 10V and 60 HZ range
- 2. Place or connect the black or blue ground clip lead from the Access Tracker's Common jack to both reference and suspect ICs or the board's ground pin.
- 3. Place or clip the red test lead from the Access Tracker's Channel a test terminal to the reference or known good IC's pin. For this example, start with pin 1 of the known good IC.
- 4. Observe the signature. This is the signature of the pin of the known good component.
- 5. Keep the red probe on pin 1, an input pin. Probe all the other input pins of the suspect component with the black probe until you have identified all the pins that have signatures that are the same as pin 1.

6. Move the red probe on pin 2, an output pin. Probe all the other output pins of the suspect component with the black probe until you have identified all the pins that have signatures that are the same as pin 2.

Review

- Integrated circuits are complex devices that are built using basic electronic components.
- The IC signatures resemble Zener diodes.
- There are many causes for IC failures and the Access Tracker can display its "health" as resistive leakage, an open or a short.
- Functionally identical pins on a single IC out-of-circuit will display the same signature.
- The most common point for reference is ground, but V_{CC} or another point might give a more informative signature.
- Different logic families exhibit different characteristic signatures.

Applications

• Testing for faulty IC's is one of the more common uses for the Tracker. A technician can compare IC's in or out of circuit.

8-2 Analog Circuits

Analog components and circuits represent another family of integrated circuit components and include operational amplifiers (op amps), comparators, references, regulators, timers and many other specialized functions. These components and circuits present more troubleshooting challenges that are unique to this particular family of ICs...

Op Amps

Frequently, each pin of an op amp creates a different signature on the Access Tracker. This signature is the result of the internal design of the chip and both the internal and external circuit elements connected to it. This type of analog component typically has many internal junctions connected to each pin and each pin may also be connected to numerous external components.

The following example will demonstrate ASA with a commonly used 741 type op amp. In this case it is configured as an inverting amplifier circuit as in the schematic below.



Figure 8-9. Op Amp Symbol and Schematic Diagram of an Inverter Circuit.

We will examine the signatures of this analog IC and present some troubleshooting concepts for this type of component.

Op Amp Signatures

Do the following to display the analog signatures of an op amp:

- 1. Select the $1K\Omega$, 15V, 60Hz.
- 2. Place or clip the black test lead from the Access Tracker's Common jack to the IC's ground or a power supply pin. For this example, the negative power supply pin of the 741 is pin 4 and the positive power supply is pin 8.
- 3. Use the red test lead from the Access Tracker's Signal jack and probe each pin of the IC.
- 4. Observe that the signatures of each of the op amp's pins are unique.



Pin 2 -InputPin 3 +InputPin 6 OutputFigure 8-10. Signatures of an Op Amp (741) at 10V, 50Ω, 60Hz with Common to Pin 4.



Pin 2 -Input

Pin 3 +Input

Pin 6 Output

Figure 8-11. Signatures of an Op Amp (741) at 20V, 20K Ω , 60Hz with Common to Pin 4.

Troubleshooting Op Am Circuits

Troubleshooting an op amp in-circuit may be very challenging. These circuits usually have numerous connections that act as feedback or compensation loops. This results in almost an infinite number of possible analog signatures. Use the comparison test method when troubleshooting op amps in-circuit. In this case, components on a suspect board are compared to those on a known good board. The Access Tracker can help locate the defective component quickly.

The op amp has three main terminals; + input, - input and output. An alternative way to perform ASA on the op amp is to connect Access Tracker's Common terminal to the op amp's output while making a comparison with the red test probe to the " + " and then the " - " leg. This eliminates problems encountered when probing op-amps that are isolated from power and common. When there is more than one op amp in a package, compare one with the other. The dual op amp and quad op amps are very common. This technique also works with comparators.

Linear Voltage Regulators

Voltage regulators are commonly found in many electronic assemblies. Some of the most popular integrated circuits of this type are three terminal devices like the 7805, a +5 volt DC regulator. The next figure shows the schematic and pin layout of the 7805 regulator. Different manufacturers implement their products with different topologies and manufacturing processes. So it's not unexpected that the same functionally equivalent component from different manufacturers may have different signatures.



Figure 8-12. Diagram and Symbol of a Linear Voltage Regulator, 7805 Type.





Input pin Output pin $15V, 1K\Omega, 200$ Hz with Ground Pin to Common Figure 8-13. Signatures of A 7805 SGS Thompson Voltage Regulator



1 Signatures of a 7805 Motorola Voltage Regulator.

Review

- Integrated circuits are complex devices that are built using basic electronic components.
- The IC signatures resemble Zener diodes.
- There are many causes for IC failures and the Access Tracker can display its "health" as resistive leakage, an open or a short.
- Functionally identical pins on a single IC out-of-circuit will display the same signature.
- The most common point for reference is ground, but V_{CC} or another point might give a more informative signature.
- Different analog IC families exhibit different characteristic signatures.

Applications

• Testing for faulty IC's is one of the more common uses for the Tracker. A technician can compare IC's in or out of circuit.

8-3 Low Voltage Integrated Circuits

There is a new family of logic that offers lower dynamic power consumption, lower operating voltages, higher output drive, faster AC speed, lower noise and better dynamic thresholds than HC CMOS. These features make this family attractive for low power applications such as battery operated portable applications (that is, laptop computers, pagers, phones, etc.).

In order to achieve this new improved level of performance, the manufacturers of this LV (low voltage) family of logic ICs have redesigned the internal structure of the device. Some manufacturers have changed the input structure by eliminating the input protection diode to V_{CC} . The design of the output structure also has changed by eliminating the output protection diode to V_{CC} and replacing it with an N-Channel pull-up transistor. As a result of these changes, the analog signatures of the LV logic family are different from the conventional HC logic family.

Do the following to view signatures of low voltage logic:

- 1. Select the 3V, $10K\Omega$ and 60Hz.
- 2. Connect the black test lead from the Access Tracker's Common jack to the IC's ground pin. For this example, the ground pin of the 74LVQ245 is pin 10.
- 3. Use the red test lead from the Access Tracker's Channel A jack and probe each pin of the IC. For this example, pins 2 to 9 and 11 to 18 are all buffer circuits so they will have identical signatures. (Note: This is only for ICs out of circuit.)
- 4. Use the red test lead from the Signal jack and probe the enable input pins. For this example, the enable pins of the 74LVQ245 are pin 1 and 19 and will have the same signatures. (Note: This is only for ICs out of circuit.)
- 5. Use the red test lead from the Access Tracker's Signal jack and probe the power supply V_{CC} input pin 20.



Buffer pinsEnable pinsVcc Power pin3V, 10KΩ, 60Hz, Ground Pin To Test CommonFigure 8-15. Signatures of a Low Voltage IC (74LVQ45 Type).

The ranges used above enhance the resistive fault signatures that are commonly found when troubleshooting this logic family. The test signal voltage V_S is lower than the TTL range groups to ensure that most descriptive signature is displayed. A higher V_S may result is a signature going toward a short with would mask out flaws. The short signature can be attributed by the LV family's lower voltage characteristics. Compare these signatures with the CMOS logic family and other discrete components such as transistors and diodes. Note that these signatures have some common similarities with the other components' analog signature we have seen already.

Review

- Integrated circuits are complex devices that are built using basic electronic components.
- The IC signatures resemble regular and Zener diode signatures.
- There are many causes for IC failures and the Access Tracker can display its "health" as resistive leakage, an open or a short.
- Functionally identical pins on a single IC out-of-circuit will display the same signature.
- The most common point for reference is ground, but V_{CC} or another point might give a more informative signature.

Applications

• Testing for faulty IC's is one of the more common uses for the Tracker. A technician can compare IC's in or out of circuit.

SECTION 9 TESTING RF (NFSA Models Only)

9-1 NFSA Probe

For information about the NFSA Probe refer to the TEV NFSA Probe Manual.

9-2 Software

For information about building test and software features for the NFSA Probe refer to the TEV NFSA Probe Manual, NFSA Software Tutorial and the Huntron Workstation Help/Manual.

9-3 Mounting a Board

The PCB under test can be mounted into the Access2 Prober at one of four levels – Top, Middle, Bottom and Base. It is important that the PCB be mounted precisely at one of these levels to ensure proper accuracy. The figure below illustrates the minimum PCB edge to Prober wall distances:



SECTION 10 APPLICATION NOTES

10-1 How to Use Front Panel Commons

The Huntron Access front panel commons are marked Common, COM1, COM2, COM3 and COM4. These common terminals are used for applications requiring more than one Common connection to the printed circuit assembly. For example, you may want to setup a board so that some components are tested with respect to the Ground terminal and others with respect to Vcc or any other power supply rail. Even though no power source is applied to the printed circuit assembly, signatures may appear significantly different with respect to different Common references.

The main common terminal Common on the Huntron Access front panel is directly connected to the common BNC jack on the Huntron Access side or back panel.

NOTE: Even though 4 Commons are available for physical connection to the printed circuit assembly, only a combination of any 2 of those 4 Commons will get shorted to the main Common terminal.

For example, In the Huntron Workstation software each range can be tested relative to Common 1 or Common 2 or Common 3 or Common 4. You will have to set up 4 ranges, each with a different **Prober Common** if you want to test it relative to all the above Commons.

10-2 Probing Boards with Tall Components

Some boards have components like capacitors, heat sinks and transformers that are more than 3 inches high. Probing the component side of these boards is difficult due to the limited Z axis up/down travel. These boards have to be probed on the solder side. However, the component may be in the way when you try to clamp the board into the slot.

The Huntron Access has an additional cutout in the base plate. This allows for additional clearance for the large components.

Remove the base cover as shown below. Mount your board so that the large components are now positioned inside the cutout.

Sometimes, the Common or Reference connections to the board-under test is difficult. The additional clearance may also make it easier to access the Common connections.



